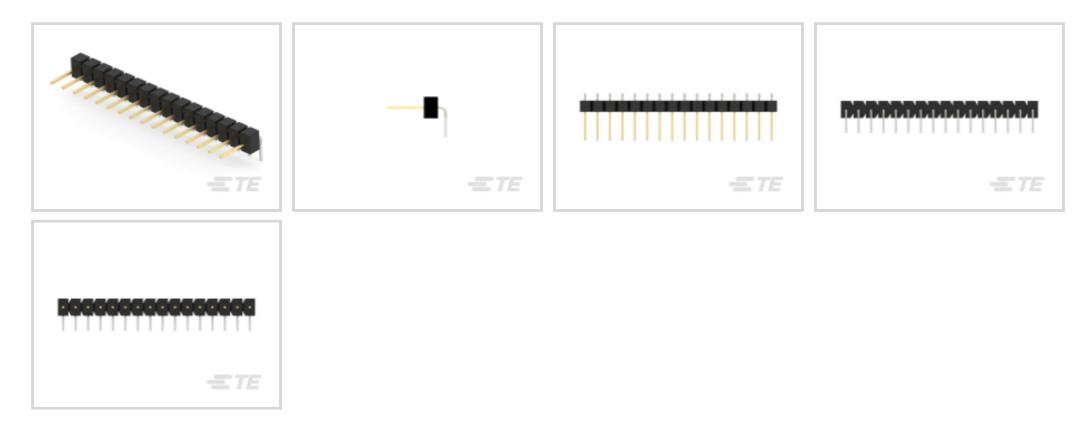


AMPMODU | AMPMODU Headers

TE Internal #: 6-103325-6 PCB Mount Header, Right Angle, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 16

Number of Rows: 1

Features

E

Product Type Features

PCB Connector Assembly Type	PCB Mount Header				
Connector System	Board-to-Board				
Header Type	Breakaway				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Connector Contact Load Condition	Fully Loaded				
PCB Mount Orientation	Right Angle				
Number of Positions	16				
Number of Rows	1				
Body Features					
Primary Product Color	Black				
Contact Features					
Mating Square Post Dimension	.64 mm[.025 in]				

S For support call+1 800 522 6752

PCB Mount Header, Right Angle, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



	100 – 200 µin		
Contact Shape & Form	Square		
Contact Underplating Material	Nickel		
PCB Contact Termination Area Plating Material	TinPhosphor BronzeGold.381 μm[15 μin]		
Contact Base Material			
Contact Mating Area Plating Material			
Contact Mating Area Plating Material Thickness			
Contact Type	Pin		
Contact Current Rating (Max)	3 A		
Fermination Features			
Square Termination Post & Tail Dimension	.64 mm[.025 in]		
Termination Post & Tail Length	3.05 mm[.12 in]		
Termination Method to Printed Circuit Board	Through Hole - Solder		
Mechanical Attachment			
Mating Alignment	Without		
PCB Mount Retention	Without		
PCB Mount Alignment	Without		
Connector Mounting Type	Board Mount		
Housing Features			
Centerline (Pitch)	2.54 mm[.1 in]		
Housing Material	Thermoplastic		
Dimensions			
PCB Thickness (Recommended)	1.6 mm[.063 in]		
Jsage Conditions			
Housing Temperature Rating	Standard		
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]		
Operation/Application			
Circuit Application	Signal		
ndustry Standards			
UL Flammability Rating	UL 94V-0		
Packaging Features			

C For support call+1 800 522 6752

11/17/2023 11:15PM | Page 2

PCB Mount Header, Right Angle, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



Packaging Quantity	25
Packaging Type	Tray
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

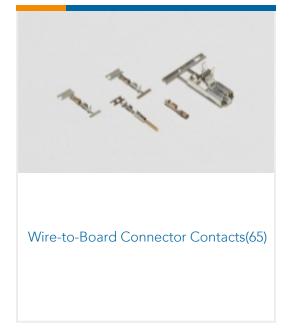


Also in the Series AMPMODU Headers

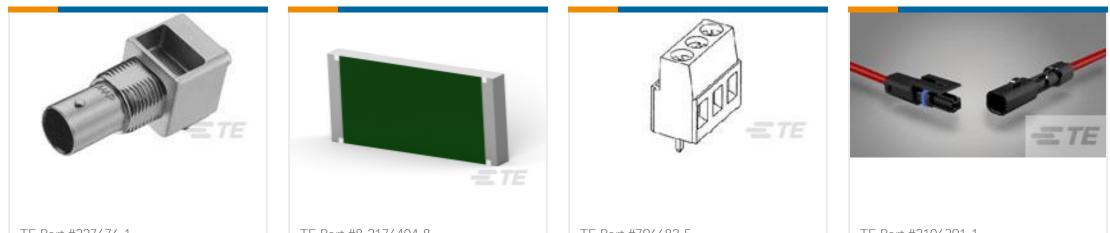
PCB Mount Header, Right Angle, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers







Customers Also Bought



TE Part #227676-1 BNC PCB RT ANGLE JACK	TE Part #8-2176404-8 3550 27R 5%	TE Part #796682-5 TERMI-BLOK PCB MOUNT 90 5P.	TE Part #2106391-1 C/A, RECPT, SLIMSEAL SSL CONN, SGL POS
			Y
TE Part #YDTS20W23-35ABV001 RECP ASSY	TE Part #644487-4 Polyester Vertical PCB Header: 2.54 mm, Shrouded, MTA 100	TE Part #86182-8 MOD I POST LP	TE Part #9-1377173-5 SMP 0-0130532-0

Documents

Product Drawings 16 MODII HD SRRA B/A .100CL,LF English CAD Files 3D PDF Customer View Model ENG_CVM_CVM_6-103325-6_G.2d_dxf.zip

C For support call+1 800 522 6752

3D

PCB Mount Header, Right Angle, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, AMPMODU Headers



English

Customer View Model ENG_CVM_CVM_6-103325-6_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6-103325-6_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the $\ensuremath{\mathsf{Terms}}$ and $\ensuremath{\mathsf{Conditions}}$ of use.

Datasheets & Catalog Pages AMPMODU Interconnetion System

AMPMODU Interconnetion System

English